
1394 Design Schematic (TSBKPCI)

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Rev M
EVM-0007M



1394 Solutions Leader

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TSBKPCI Designer Kit

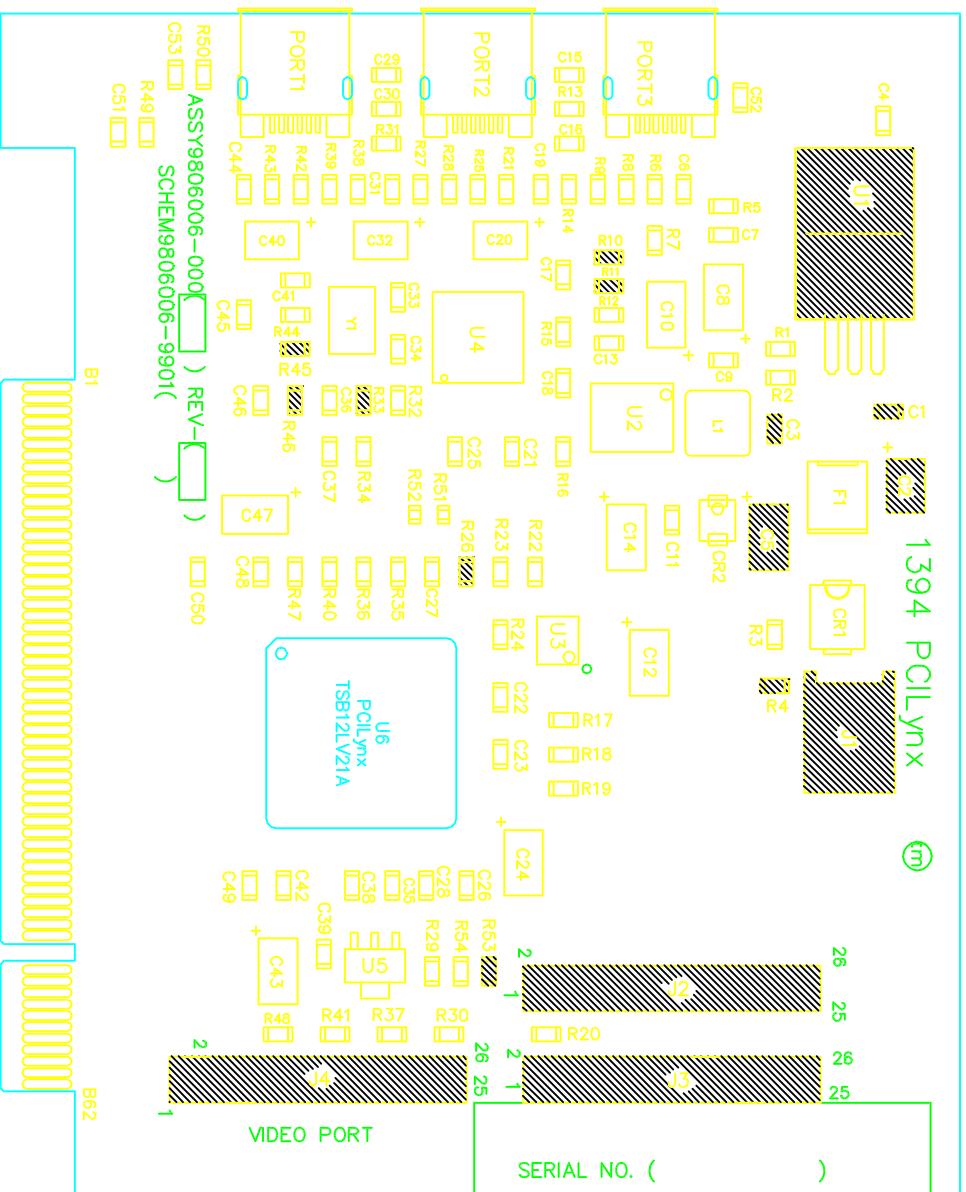
- Interfacing TSB12LV21A to TSB21LV03A
- Interfacing Serial EEPROM to TSB12LV21A
- Minimal Implementation of PCILynx Architecture (PCI to 1394 Card Example)
- Lynxsoft™ Application Software Included

DESIGNED AND MANUFACTURED FOR:



TEXAS
INSTRUMENTS

BY



INDICATES THIS COMPONENT NOT
POPULATED FOR THIS DASH NUMBER.

TSBKPCI "LITE CARD"
ASSY 9806006-0003 REV 'K'
(SWITCHER V REG)
PWB 9806007-0001 REV 'C'

Revised 11/6/1997

These are things to keep in mind when looking at the TSBKPCI reference design schematic, revision "M" implementing the TSB12LV21A and TSB21LV03A.

1. Page 2 shows the circuitry for a 3 port - 200Mbps cable physical layer chip (TSB21LV03A) using an external 24.576MHz crystal for the clock reference. On this schematic page note that isolation mode pin 62 (ISO-) is tied high.

R12 and R15 enable the GPIO D0 line to program the state of the configuration manager capable input, or contenderbit , on the PHY.

The termination resistors R6, 8, 9, 14, 21, 25, 27, 28, 38, 39, 42, and 43 should be 55Ohms not 56.2 as shown on the schematic.

2. Page 3 shows the connections for the J2, J3, and J4 connectors for connecting the auxiliary local bus signals and the GPIO signals for use off this board.

3. Page 4 shows the connections to the TSB12LV21APCILynx, link layer chip. On this schematic page note that to disable isolation mode pin 136 (LINK_ISO#) should be tied high (correctly called a 3.3 VVcc pin in the PCILynx data sheet for this reason).

R54 and R53 are not needed with TSB12LV21A, they allow optional GPIO3 control over the Vsync of the ZV port.

4. Page 5 contains the voltage regulator to provide 3.0V power to the TSB21LV03 PHY chips, a regulator to provide 3.3V power to the PCILynx chip, and the connections to the serial EEPROM.

5. This schematic does not implement isolation. As shown, Link ground is the same as PHY ground. The cable shield is tied directly to chassis ground. Once the card is inserted into a card slot, link ground is tied to chassis ground. This is not compliant with the 1394-1995 standard, but is believed to reduce EMI emissions.

TI 1394 Applications Engineering

This TSBKPCI host adaptor was designed and manufactured for Texas Instruments by Solelectron Texas.

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*** ADVANCE INFORMATION ***

NOTE:

These schematics have not been verified or tested and contain advance information concerning a technology in development. Function, specification, and pin assignment are all subject to change without notice."

REVISIONS

REV	ECN NO / CLASS / DRAFTER / DATE	DATE	APPROVED
A	Tuesday, June 10, 1997		
B	Connect CMC_LKON to GPIO_DATA0	June 20, 1996	
C	Add pulldn resistor to CTL0 & CTL1	Sept 23, 1996	
D	Add R's to ZV_VSYNC & chge shield gnd	Oct 1, 1996	
E	Add Rev A PCI Lynx	Oct 30, 1996	
F	Change R50,C52,C53 to ZERO ohm resistors	Dec 26, 1996	
F	Change C14 to a 3.3UF 50 Volt Cap	Dec 26, 1996	
G	Add Rev 02 PCI Lynx	Feb 11, 1997	
H	Replace 3.3V Reg w/Adj to run at 3.0V	Mar 07, 1997	
J	REV02 PCILynx with Adj Reg at 3.0V	Mar 07, 1997	
K	Update PWB artwork for ADJ REG, Short	Mar 17, 1997	
	cable shield to logic gnd, remove AV conn		
L	Update PWB: connector shield to chassis gnd	Jun 17, 1997	
	connector pin 2 to logic gnd		
M	Change to Rev. A Phy (TSB21LV03A), change	Oct 08, 1997	
	value of R34, R51, R52 to 1K ohm		

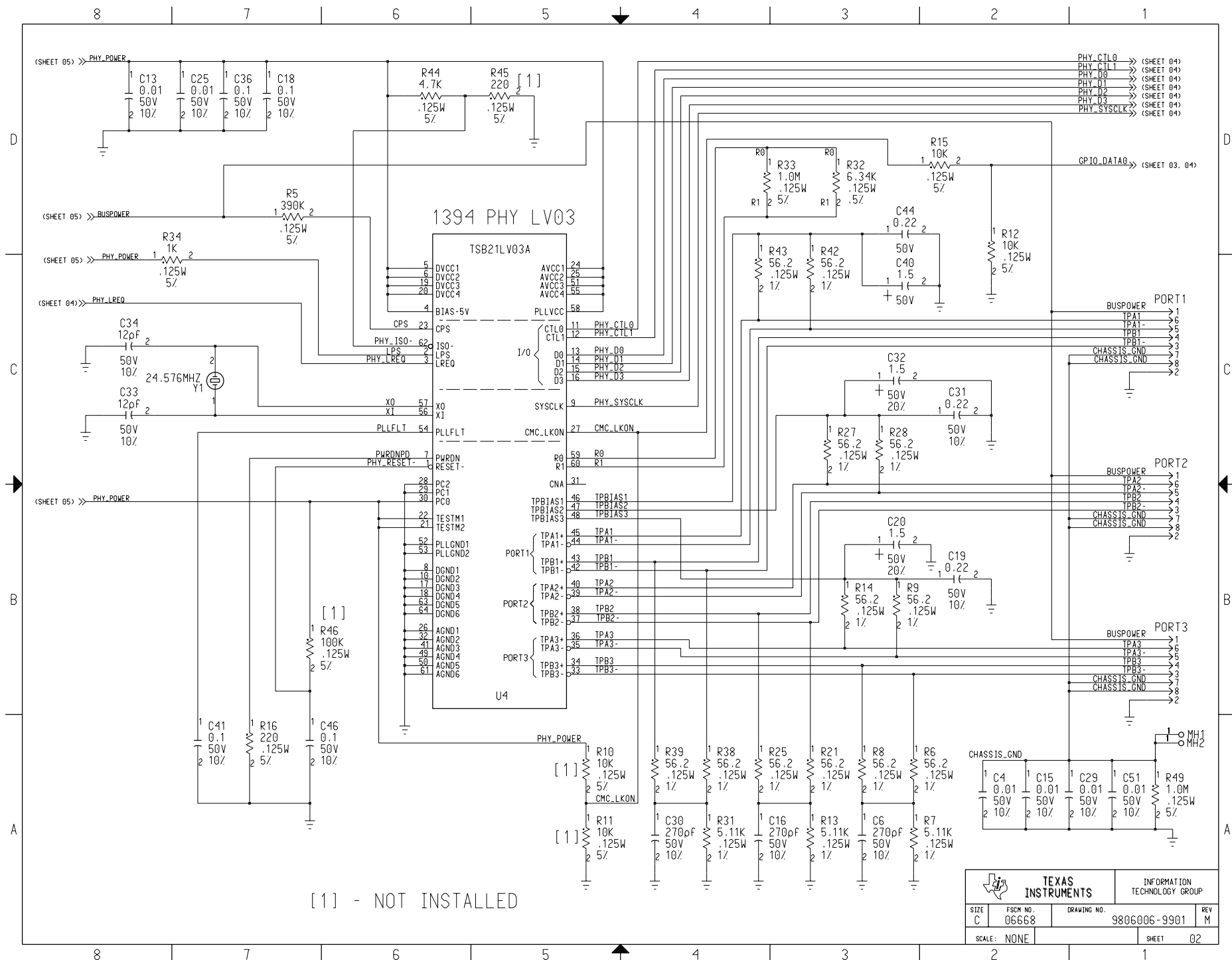
BUILD OPTIONS

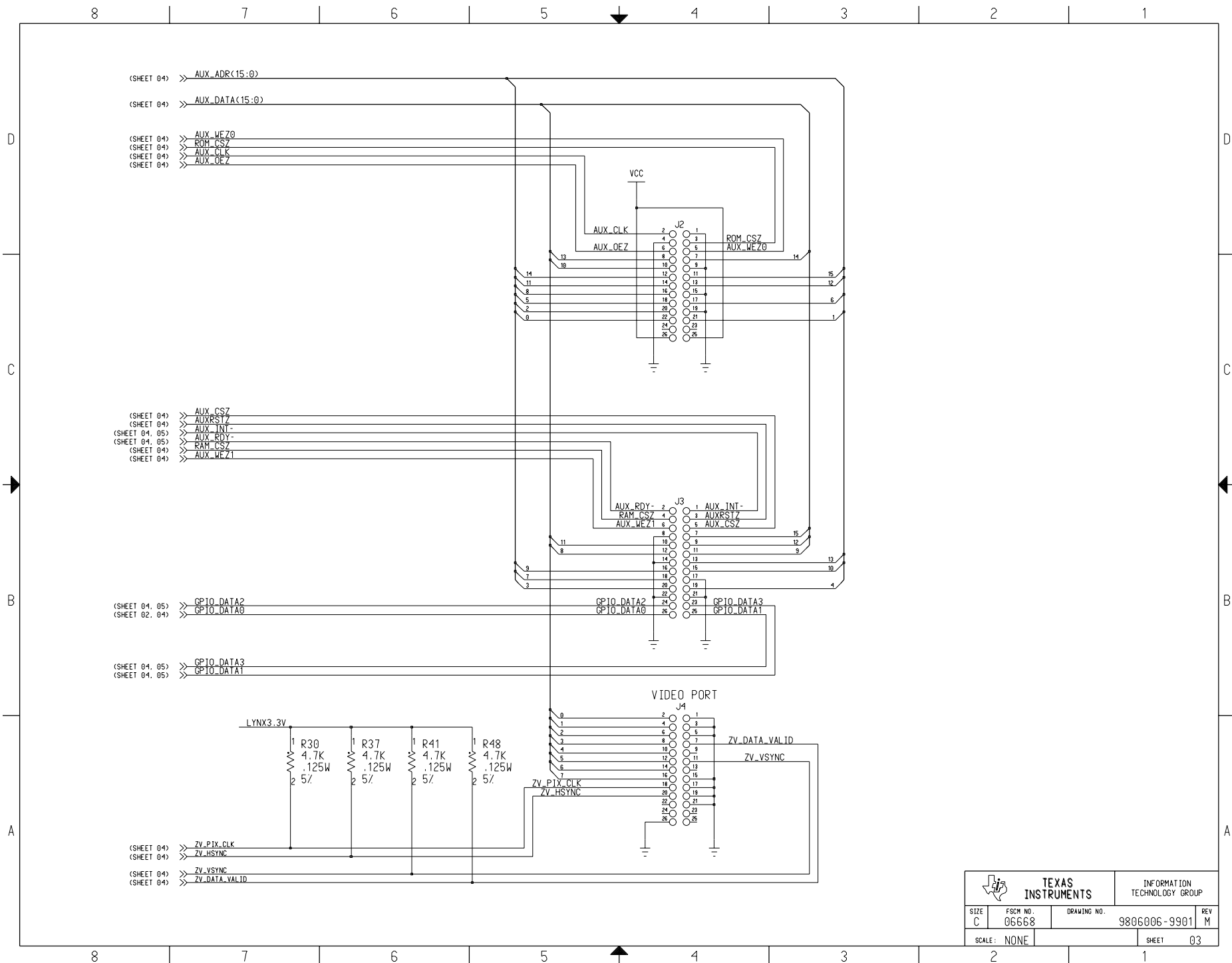
-0004	LINEAR PHY POWER REGULATOR BUS POWER FROM PCI CONNECTOR (+12V)
-0003	SWITCHING PHY POWER REGULATOR BUS POWER FROM PCI CONNECTOR (+12V)
-0002	LINEAR PHY POWER REGULATOR BUS POWER FROM SPECIAL POWER CONNECTOR
-0001	SWITCHING PHY POWER REGULATOR BUS POWER FROM SPECIAL POWER CONNECTOR

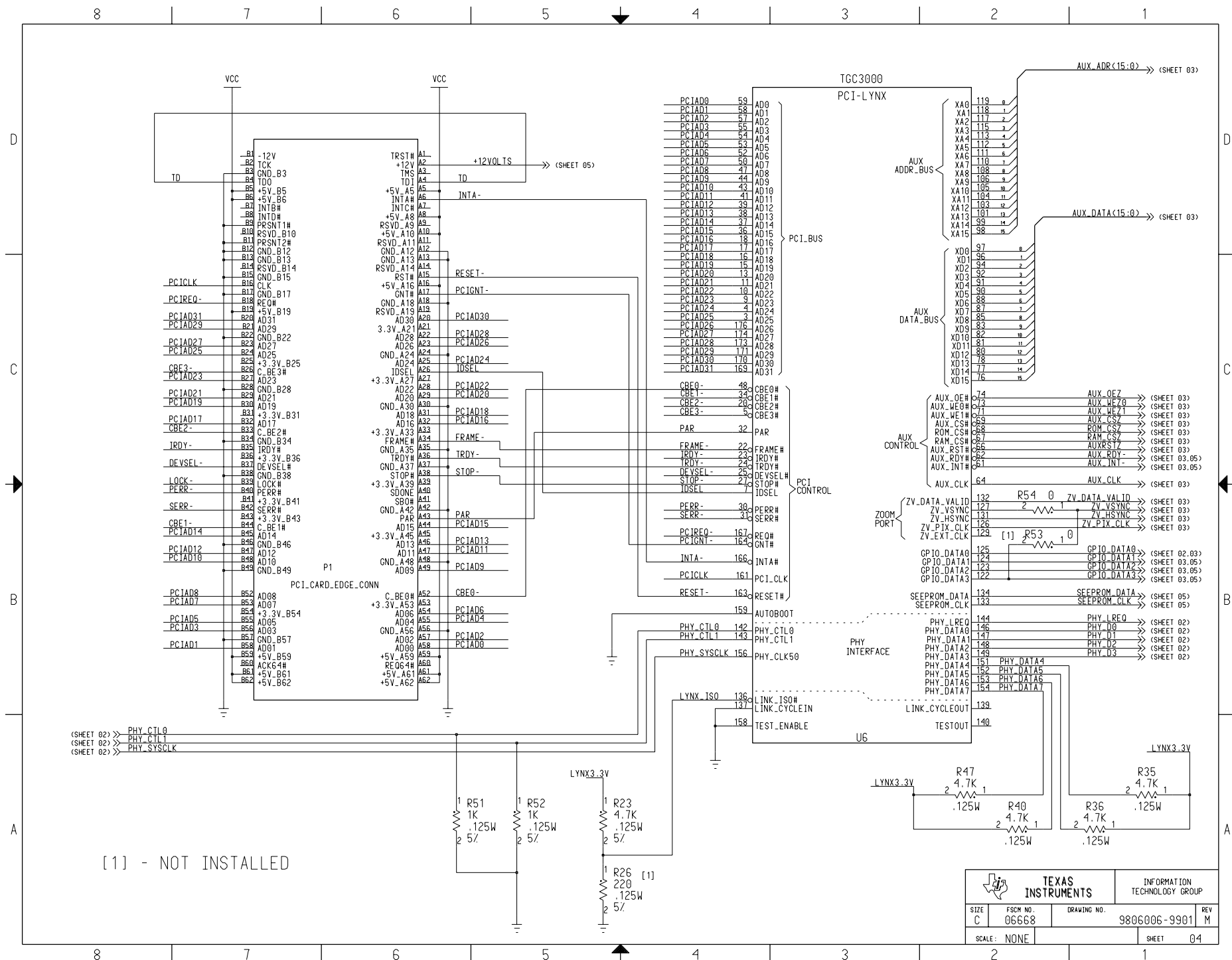
Assy Rev.	PCILynx Rev.	PCILynx Part Number
*	00	TSB12LV21PGF
A	00	TSB12LV21PGF
B	00	TSB12LV21PGF
C	00	TSB12LV21PGF
D	00	TSB12LV21PGF
E	01	PTS812LV21APGF
F	00	TSB12LV21PGF
G	02	TSB12LV21APGF PTS812LV21APGF
H	00	TSB12LV21PGF
J	02	TSB12LV21APGF
K	02	TSB12LV21APGF
L	02	TSB12LV21APGF
M	02	TSB12LV21APGF

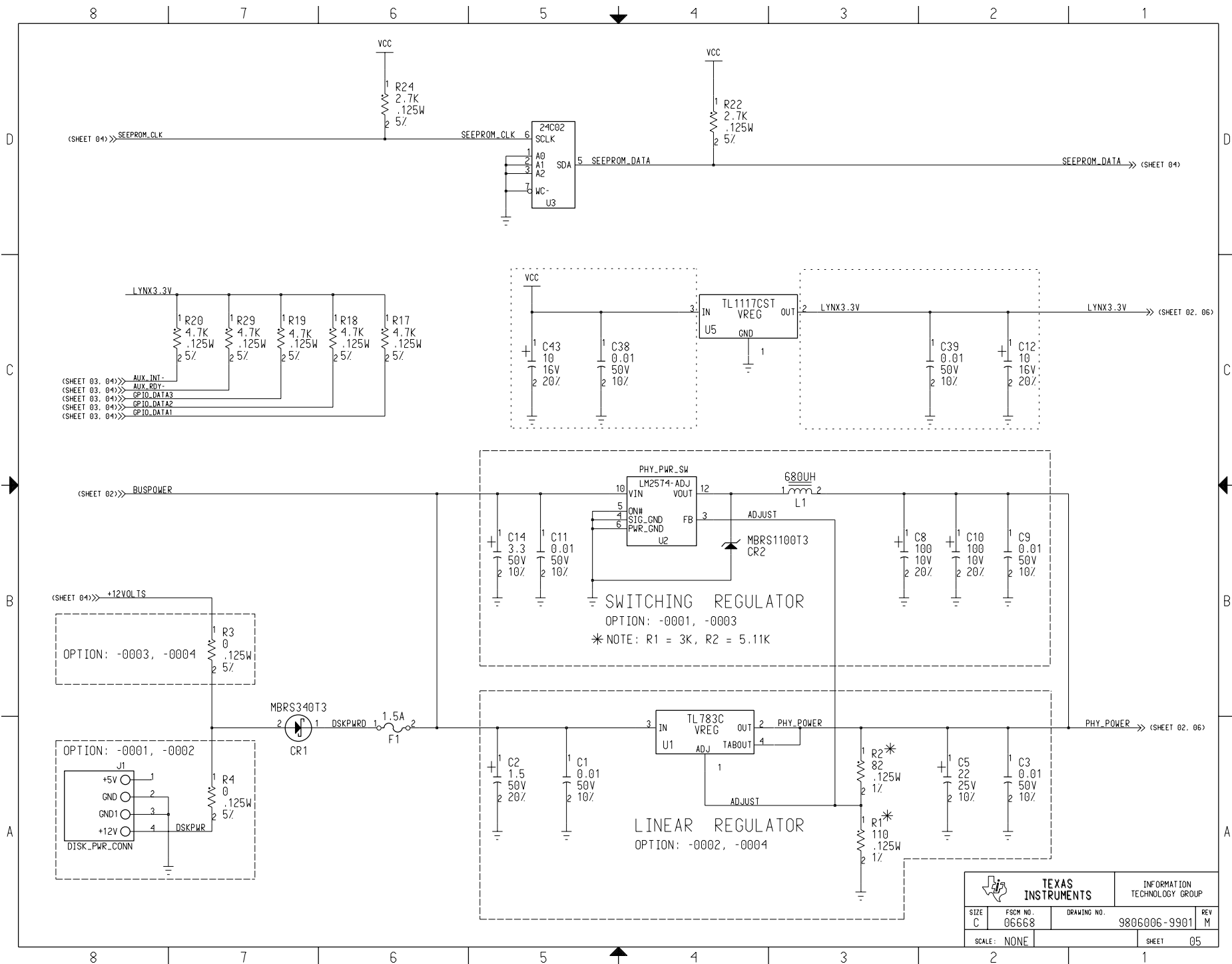
Tuesday, June 10, 1997 7:30:32 am

-1 QTY	ITEM NO	PART OR IDENTIFYING NUMBER	NOMENCLATURE DESCRIPTION	NOTES
			DWN	
			CHK	
			ENGR-DSGN	
			ENGR-MGR	
			QA	
			MFG	
			PROD SAF	
			RLSE	
			SCALE	
			SIZE	
			FSCM NO.	
			DRAWING NO.	
			PROJ NO.	
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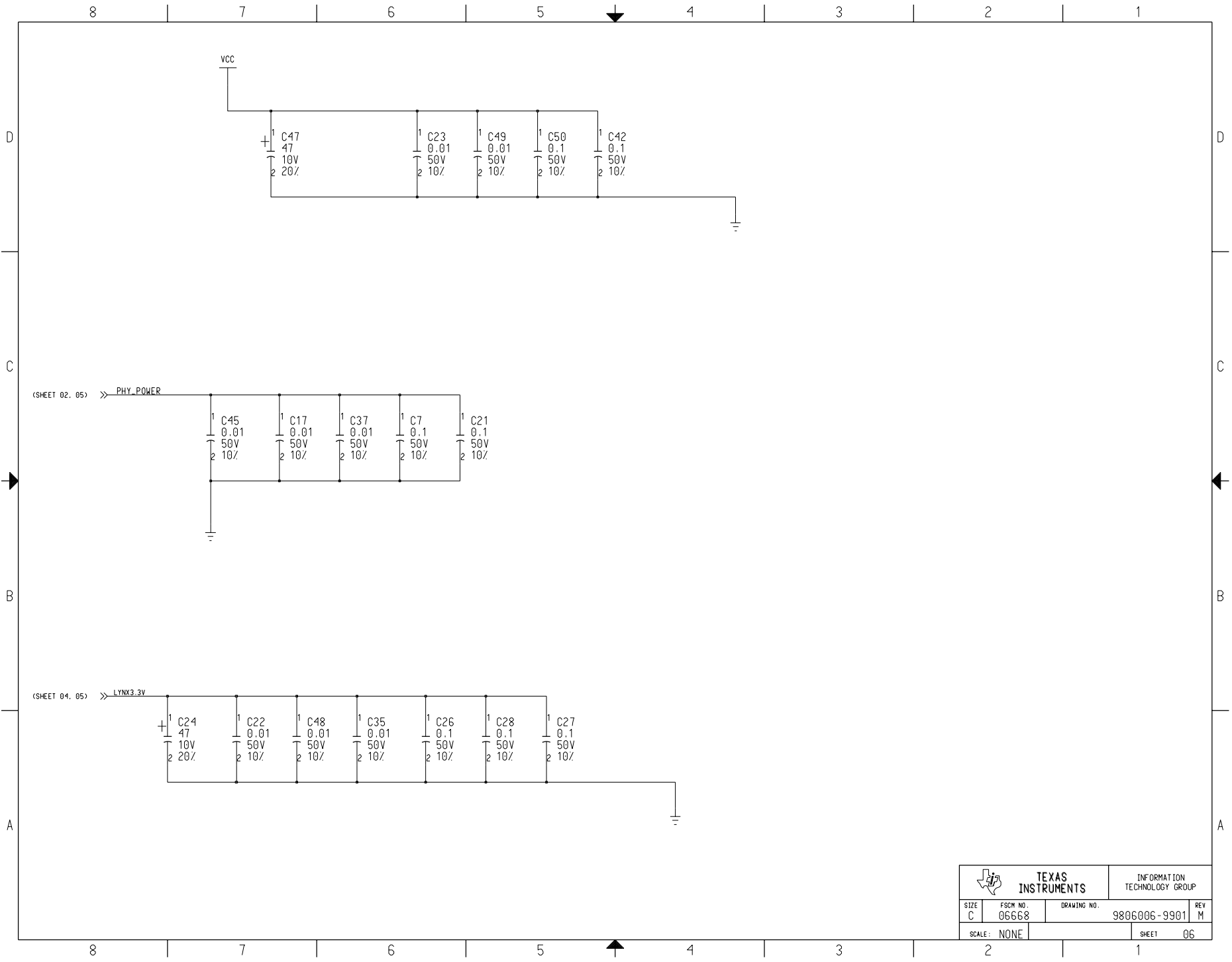









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SIZE C	FSCM NO. 06668	DRAWING NO. 9806006-9901	REV M		
SCALE: NONE			SHEET 05		



		TEXAS INSTRUMENTS		INFORMATION TECHNOLOGY GROUP	
SIZE C	FSCM NO. 06668	DRAWING NO. 9806006-9901		REV M	
SCALE : NONE				SHEET 06	



**TSBKPCI “1394 Lite Card” P/N 9806006-3 (Switcher Vreg) Rev M assy / Rev D PWB
(made for Texas Instruments by Solectron Texas)**

** Change from Rev L - update to TSB21LV03A PHY and associated parts*

DESCRIPTION	Supplier	Part Number	Pkg	Qty	Reference Designator
RES, 56.2, 1%	KOA	RK73H2BT56R2	1206	12	R6 R8 R9 R14 R21 R25 R27 R28 R38
					R39 R42 R43
RES, 220, 5%	KOA	RM73B2BT221J	1206	1	R16
RES, 4.7K, 5%	KOA	RM73B2BT472J	1206	15	R17 R18 R19 R20 R23 R29 R30 R35
					R36 R37 R40 R41 R44 R47 R48
RES, 0, n/a	KOA	RM73Z2BT	1206	5	R3 R50 R54 C52 C53 - (NO LOAD R4 & R53)
RES, 1.0M, 5%	KOA	RM73B2BT105J	1206	2	R49 R33
RES, 6.34K, 0.5%	KOA	RK73H2BT6341D	1206	1	R32
RES, 390K, 5%	KOA	RM73B2BT394J	1206	1	R5
CAP, 0.01, 10%	KEMET	C1206C103K5RAC	1206	18	C4 C9 C11 C13 C15 C17 C22
					C23 C25 C29 C35 C37 C38 C39 C45
					C48 C49 C51 - (NO LOAD C1 C3)
CAP, 47, 20%	KEMET	T491D476M010AS	2816	2	C24 C47
CAP, 1.5uF, 50V	KEMET	T491C155M050AS	2313	3	C20 C32 C40 - (NO LOAD C2)
CAP, 3.3uF, 50V	KEMET	T491D335M050AS	2816	1	C14 - (NO LOAD C5)
RES, 5.11K	KOA	RK73H2BT5111F	1206	4	R2 R7 R13 R31
FUSE, 1.5A	RayChem	SMD150-2	3820fuse	1	F1
CAP, 0.1, 10%	KEMET	C1206C104K5RAC	1206	11	C7 C18 C21 C26 C27 C28 C36 C41 C42
					C46 C50
CAP, 0.22, 10	AVX	12065C224KAT4A	1206	3	C19 C31 C44
XTAL, 24.576MHZ	FOX	FE 24.576 20PF	xtal_fe	1	Y1
1394 R/A Flat Header	Molex	53462-0611	socket_6	3	PORT1 PORT2 PORT3
RES, 10K, 5%	KOA	RM73B2BT103J	1206	2	R12 R15
CAP, 12PF, 10%	KEMET	C1206C120K5GAC	1206	2	C33 C34
CAP, 270PF, 10%	KEMET	C1206C271J5GAC	1206	3	C6 C16 C30
PCI BRACKET	GLOBE	G5025	spec.	1	
HEX HEAD SCREW	MEDALIST	SEMS, 4-40 X 1/4		2	
PCI-Lynx ASIC Rev 2	TI	TSB12LV21APGF	qfp-176	1	U6
TSB21LV03A	TI	TSB21LV03A	qfp64	1	U4
Volt Reg, ADJ	Nat'l	LM2574HVM-ADJ	soic14w	1	U2
680uH, 20%	TDK	SLF7032T-681MR18	ind_slf7032	1	L1
2K-Bit Serial EEprom	Natl Semi	CAT24WC02J	soic8	1	U3
RES, 2.7K	KOA	RM73B2BT272J	1206	2	R22 R24
CAP, 10, 20%, 16V	Kemet	T491D106K016AS	2816	2	C12 C43
CAP, 100, 20%, 10V	Kemet	T495X107M010AS	2816	2	C8 C10
LT1117CST-3.3	Linear Tech	LT1117CST-3.3	sot_223	1	U5
DIODE, MBRS1100T3	Motorola	MBRS1100T3	1815j	1	CR2
DIODE, MBRS340T3	Motorola	MBRS340T3	2824	1	CR1
RES, 1.0K	KOA	RM73B2AT102J	805	2	R51 R52
RES, 1.0K	KOA	RM73B2BT102J	1206	1	R34
RES, 3.0K	KOA	RK73B2BT302J	1206	1	R1